

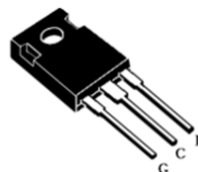
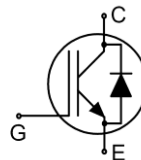


TT010N120EI

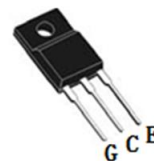
主要参数 MAIN CHARACTERISTICS

I _c	10 A
V _{CES}	1200V
V _{cesat-typ} (V _{ge} =15V)	1.6V

封装 Package



TO-247



用途

- 逆变器

APPLICATIONS

- General purpose inverters

产品特性

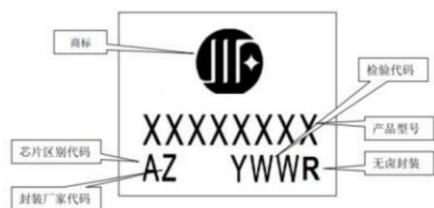
- 低栅极电荷
- Trench FS 技术
- RoHS 产品

FEATURES

- Low gate charge
- Trench FS Technology
- RoHS product

印记定义

Mark definition



检验代码说明: Y(年代码, 执行内部定义)+WW (周代码)

产品型号说明: 产品类型+工艺平台+电流+频率+电压+工艺版本+特殊特性。

订货信息 ORDER MESSAGE

订货型号 Order codes	印记 Marking	封装 Package
无卤-条管 Halogen-Free-Tube		
TT010N120EI-GE-BR	TT010N120EI	TO-247
TT010N120EI-F-BR	TT010N120EI	TO-220MF

绝对最大额定值 ABSOLUTE RATINGS ($T_c=25^\circ\text{C}$)

项 目 Parameter	符 号 Symbol	数 值 Value	单 位 Unit
最高集电极-发射极直流电压 Collector-Emitter Voltage	V_{ce}	1200	V
*连续集电极电流 Collector Current-continuous	I_c $T=25^\circ\text{C}$	20	A
	I_c $T=100^\circ\text{C}$	10	A
最大脉冲集电极极电流 (注 1) Collector Current – pulse (note 1)	I_{CM}	20	A
栅极发射极电压 Gate-Emitter Voltage	V_{GE}	± 20	V
耗散功率 Power Dissipation	P_D $T_c=25^\circ\text{C}$	176(TO-247)	W
结温 Junction Temperature Range	T_{vj}	$-40\sim+175$	$^\circ\text{C}$
存储温度 Storage Temperature Range	T_{STG}	$-55\sim+150$	$^\circ\text{C}$
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T_L	260	$^\circ\text{C}$

*连续集电极电流由最高结温限制

*Collector current limited by maximum junction temperature

注释:

1: 脉冲宽度由最高结温限制

Notes:

1: Pulse width limited by maximum junction temperature



电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
集电极-发射极击穿电压 Collector-Emitter Voltage	BV_{CES}	$I_C=250\mu A, V_{GE}=0V$	1200	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	$\Delta BV_{CES}/\Delta T_J$	$I_C=0.5mA$, referenced to $25^\circ C$	-	0.6	-	V/ $^\circ C$
零栅压下集电极漏电流 Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V, T_C=25^\circ C$	-	-	0.2	mA
		$V_{CE}=1200V, V_{GE}=0V, T_C=175^\circ C$	-	2	-	mA
正向栅极体漏电流 Gate-body leakage current, forward	I_{GESF}	$V_{CE}=0V, V_{GE}=20V$	-	-	200	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I_{GESR}	$V_{CE}=0V, V_{GE}=-20V$	-	-	-200	nA
通态特性 On-Characteristics						
阈值电压 Gate Threshold Voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C=250\mu A$	4.5	5.5	6.5	V
饱和压降 Collector-Emitter saturation Voltage	V_{CESAT}	$V_{GE}=15V, I_C=10A, T_C=25^\circ C$	-	1.6	2.1	V
		$V_{GE}=15V, I_C=10A, T_C=175^\circ C$	-	1.9	-	V
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V, f=1.0MHz$	-	900	-	pF
输出电容 Output capacitance	C_{oes}		-	60	-	pF
反向传输电容 Reverse transfer capacitance	C_{res}		-	30	-	pF
栅极电荷总量 Total Gate Charge	Q_g	$V_{CC}=600V, I_C=10A, V_{GE}=15V, T_C=25^\circ C$	-	80	-	nC
栅极-反射极 Gate to emitter charge	Q_{ge}		-	6	-	
栅极-集电极 Gate to collector charge	Q_{gc}		-	60	-	
栅极电阻-Gate resistance	R_g	$f=1 MHz$, open collector	-	2	-	Ω
短路电流-short current	I_{sc}	$V_{GE}=15V, V_{CE}=600V, t_{sc} < 10\mu s$	-	41.3	-	A



电特性 ELECTRICAL CHARACTERISTICS

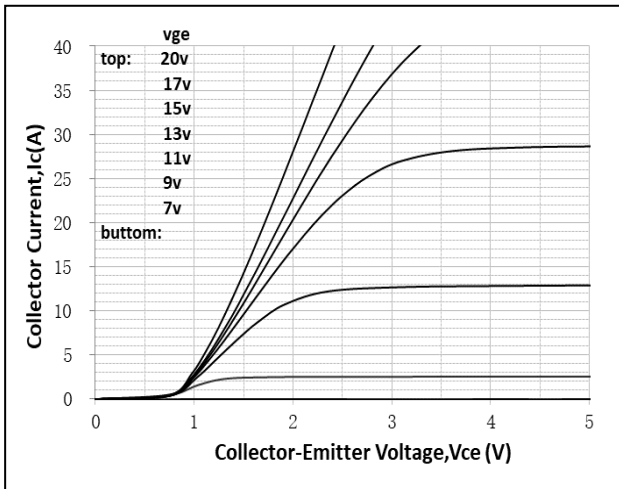
开关特性 Switching Characteristics						
项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
开启延迟时间 Turn-on delay time	$t_d(\text{on})$	$V_{CC}=600V, I_c=10A, R_G=10\Omega$ $V_{GE}=15V, T_C=25^\circ\text{C}$	-	17.5	-	ns
上升时间 Turn-on rise time	t_r		-	18.7	-	ns
关断延迟时间 Turn-off delay time	$t_d(\text{off})$		-	109	-	ns
下降时间 Turn-off Fall time	t_f		-	340	-	ns
开通损耗 Turn-on energy	E_{on}		-	0.24	-	mJ
关断损耗 Turn-off energy	E_{off}		-	0.93	-	mJ
总开关损耗 Total switching energy	E_{tot}		-	1.17	-	mJ
开启延迟时间 Turn-on delay time	$t_d(\text{on})$	$V_{CC}=600V, I_c=10A, R_G=10\Omega$ $V_{GE}=15V, T_C=175^\circ\text{C}$	-	17	-	ns
上升时间 Turn-on rise time	t_r		-	22	-	ns
关断延迟时间 Turn-off delay time	$t_d(\text{off})$		-	131	-	ns
下降时间 Turn-off Fall time	t_f		-	537	-	ns
开通损耗 Turn-on energy	E_{on}		-	0.46	-	mJ
关断损耗 Turn-off energy	E_{off}		-	1.38	-	mJ
总开关损耗 Total switching energy	E_{tot}		-	1.84	-	mJ

项 目 Parameter	符 号 Symbol	最大值 MAX		单 位 Unit
		TO-247	TO-220MF	
结到管壳的热阻 Thermal Resistance, Junction to Case	$R_{th(j-c)}$ IGBT	0.85	3.6	$^\circ\text{C/W}$
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	40	62.5	$^\circ\text{C/W}$

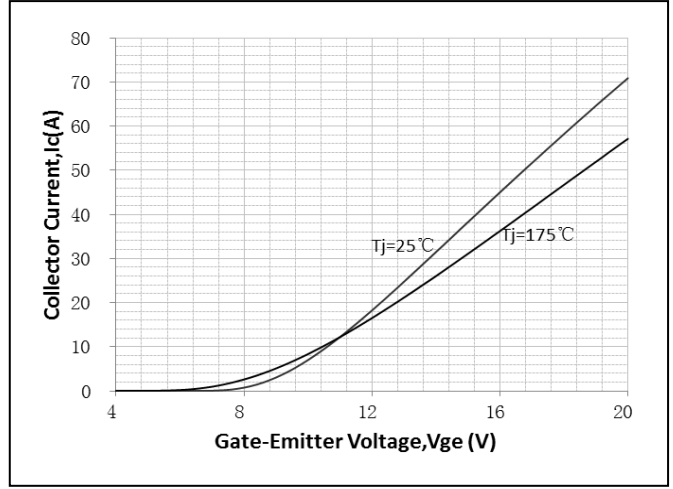


特征曲线 ELECTRICAL CHARACTERISTICS (curves)

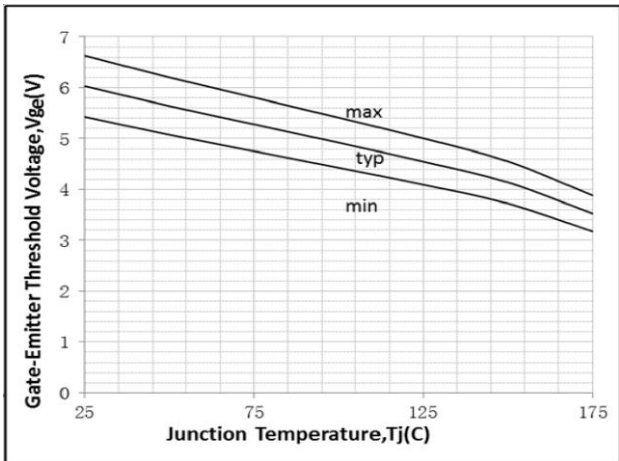
Output Characteristics (25°C)



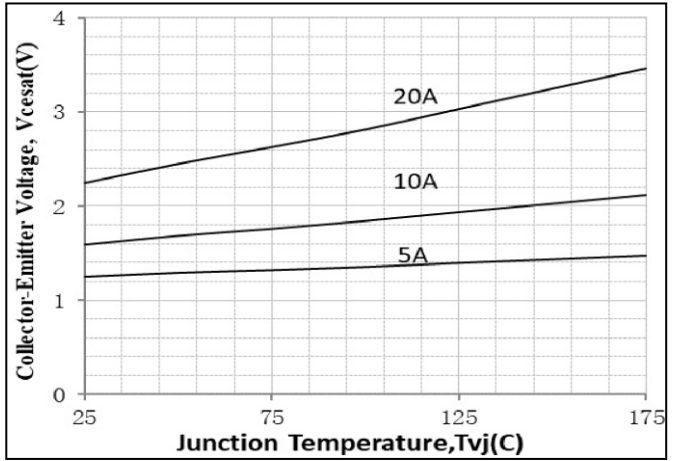
Transfer Characteristics



VTH vs. Tj

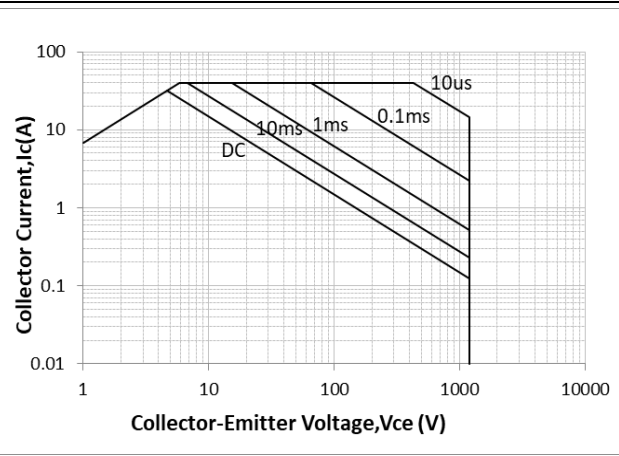


Vcesat vs. Tj



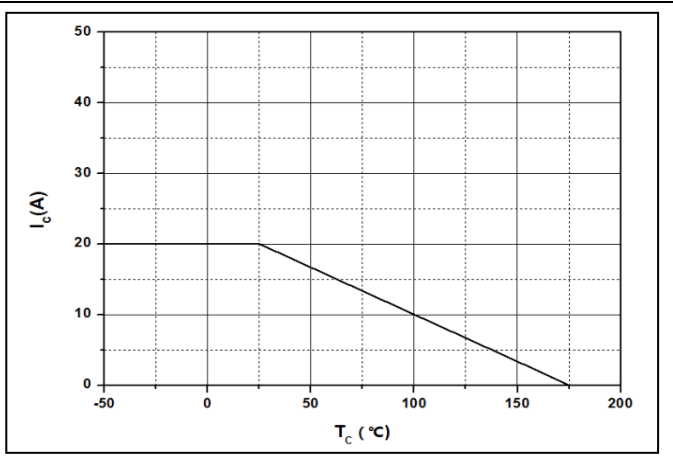
Forward Bias SOA

$T_c = 25^\circ\text{C}$, $V_{GE} = 15\text{V}$, $T_j \leq 175^\circ\text{C}$



Collector current vs. case temperature

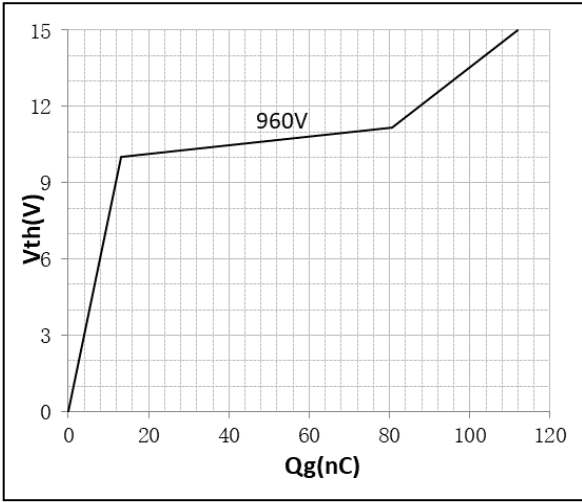
$V_{GE} \geq 15\text{V}$, $T_j \leq 175^\circ\text{C}$





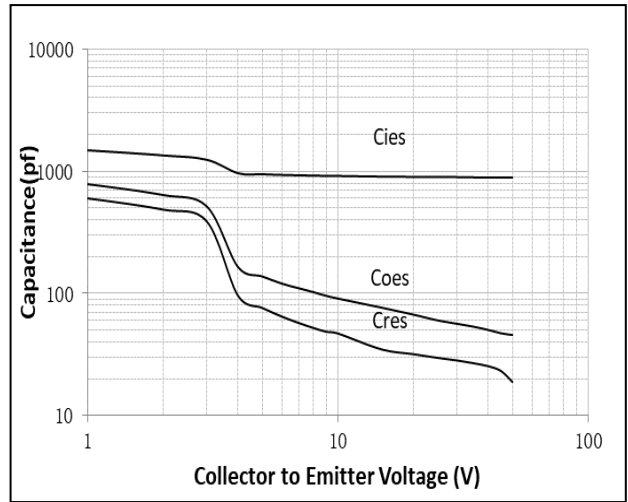
Gate Charge Characteristics

VGE=15V, IC=25A



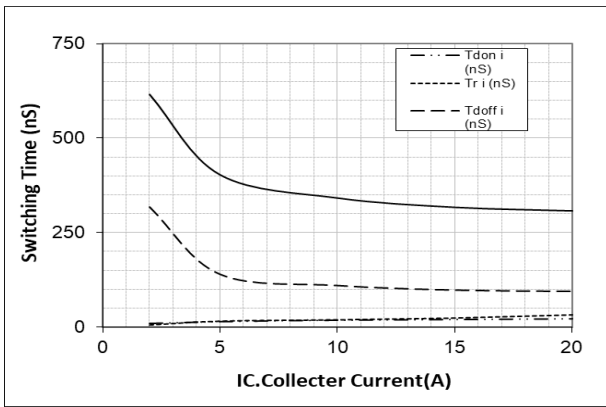
Capacitance Characteristic

Vce=25V, VGE =0V, f=1.0MHZ



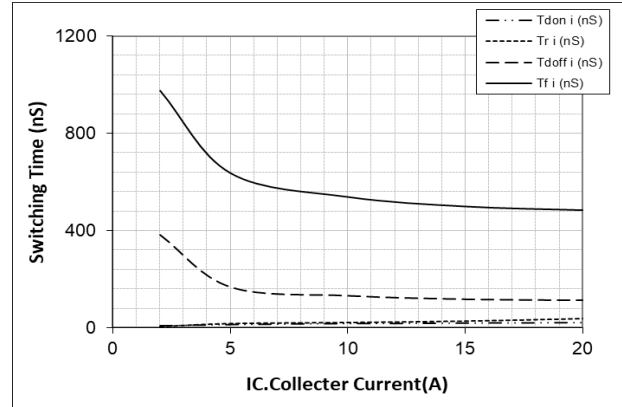
Switching Time vs. IC(25°C)

VCE=600V, VGE=15V, RG=10Ω



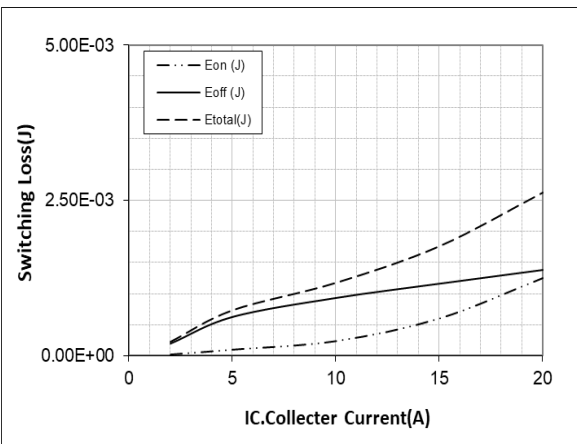
Switching Time vs. IC(175°C)

VCE=600V, VGE=15V, RG=10Ω



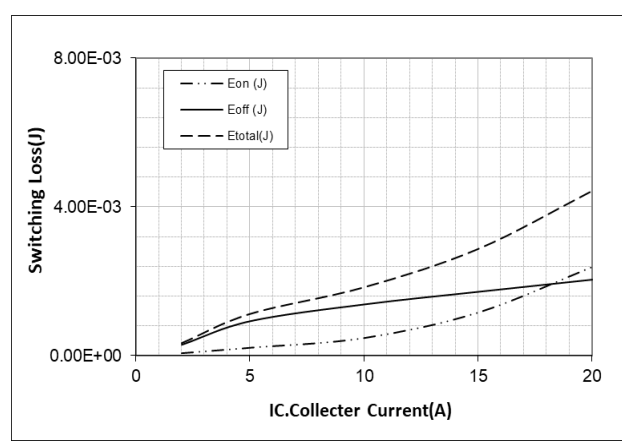
Switching Loss vs. IC(25°C)

VGE=15V, VCE=600V, Rg=10Ω



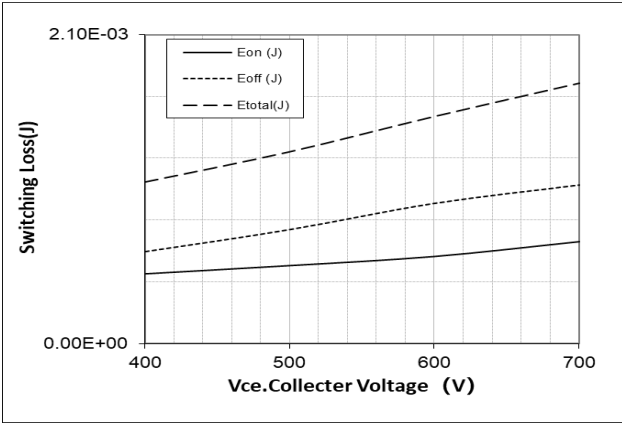
Switching Loss vs. IC(175°C)

VGE=15V, VCE=600V, Rg=10Ω

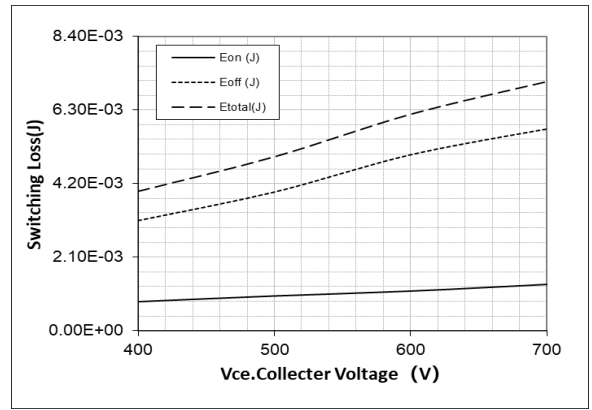




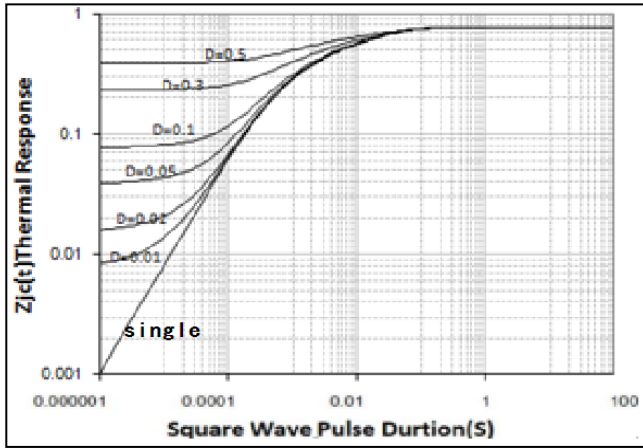
Switching Loss vs. VCE(25°C)



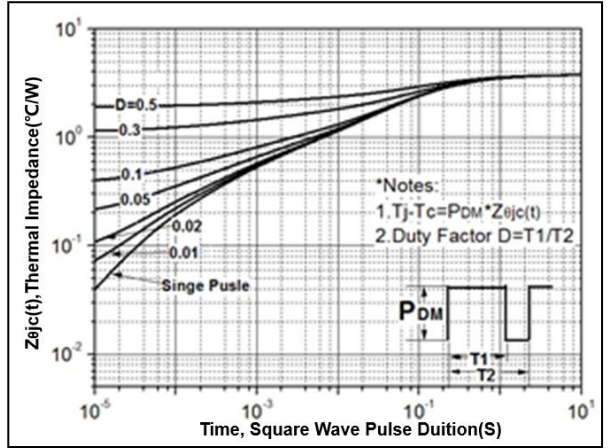
Switching Loss vs. VCE(175°C)



Normalized Maximum Transient Thermal Impedance for IGBT(RJC)-TO-247



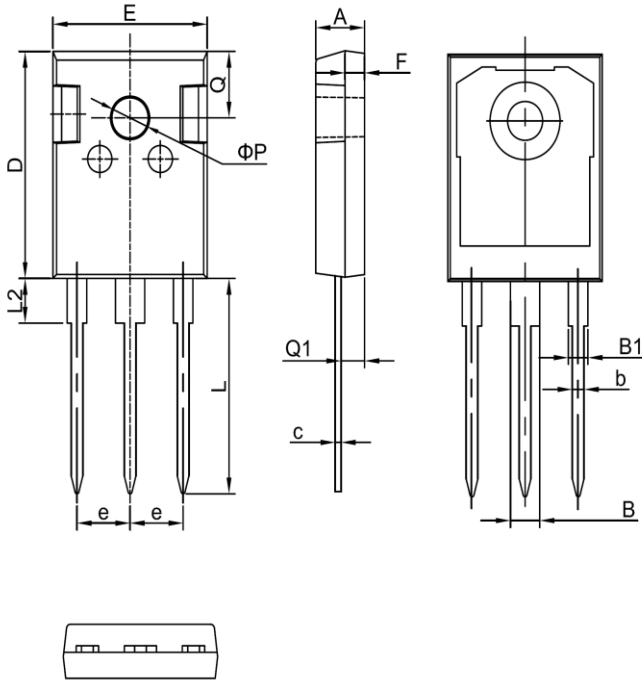
Normalized Maximum Transient Thermal Impedance for IGBT(RJC)-TO-220MF





TO-247

单位 Unit : mm



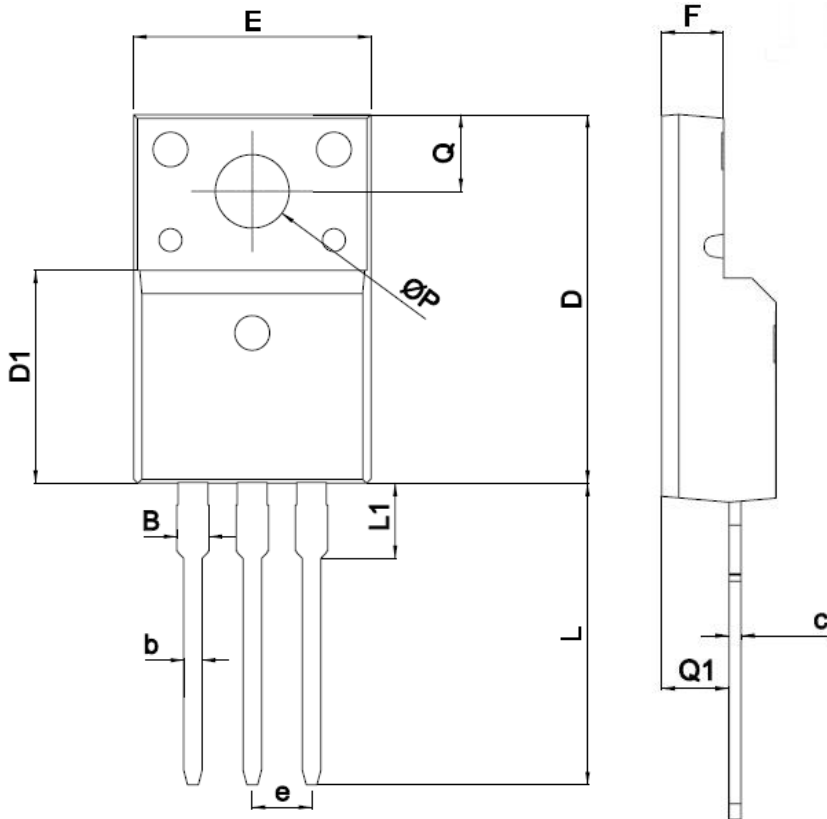
符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70



外形尺寸PACKAGE MECHANICAL DATA

TO-220MF

单位 UNIT:mm



SYMBOL	mm	
	MIN	MAX
A	4.5	4.9
B		1.47
b	0.7	0.9
c	0.45	0.60
D	15.67	16.07
D1	9.04	9.20
e	2.54TYPE	
E	9.96	10.36
F	2.34	2.74
L	12.58	13.38
L1	3.13	3.33
Q	3.2	3.4
Q1	2.56	2.96
ΦP	3.08	3.28





注意事项

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3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
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